

1MHz - 8000MHz

Device Features

- 6-bit Serial & Parallel Interface
- 31.5 dB Control Range 0.5 dB step
- Support addressable Function (Addr0-Addr7)
- Glitch-safe attenuation state transitions
- 2.7 V to 5.5 V supply
- 1.8 V or 3.3 V control logic
- **Excellent Attenuation Accuracy**

 \pm (0.15 + 1.5% of attenuation state) @ 1.9GHz

 \pm (0.25 + 3.5% of attenuation state) @ 3.5GHz

 \pm (0.35 + 7.0% of attenuation state) @ 7.2GHz

- Low Insertion Loss
 - 0.8 dB @ 1.9GHz
 - 1.2 dB @ 3.5GHz
 - 2.3 dB @ 7.2GHz (Optimized Application)
- Ultra linearity IIP3 > +63dBm @ 3.5GHz, ATT=0dB
- Input 0.1dB Compression (IP0.1dB) 29dBm @ 3.5GHz, ATT=0dB
- Programming modes
 - Direct parallel
 - Latched parallel
 - Serial Addressable
- Stable Integral Non-Linearity over temperature
- Low Current Consumption 200 µA typical
- -40 °C to +105 °C operating temperature
- ESD rating: Class1C (1KV HBM)
- Lead-free/RoHS2-compliant 24-lead 4mm x 4mm x 0.9mm QFN SMT package (Pb), (<u>C</u>) (<u>G</u>)

Product Description

The BDA4630 is a broadband, Highly accurate 50Ω digital step attenuator model which provides adjustable attenuation from 0 to 31.5 dB in 0.5 dB steps. The control interface supports a 6-bit serial interface with 3-bit addressable function and latched parallel interface.

BDA4630 supports a broad operating frequency range from 1MHz to 8.0 GHz. BDA4630 is offering the High linearity, low power consumption, low insertion loss, high attenuation accuracy and low insertion loss less than 2.1dB typical at all frequency band.

The device features a safe state transitions with no negative/positive Glitch technology optimized for excellent step accuracy.

Basically the RF input and output are internally matched to 50Ω and do not require any external matching components. Besides there is no need for DC blocking Capacitor If DC is not presented at the RF Port . In some cases to optimize Return loss for above 4 - 8GHz, Shunt capacitor can be added near RF1 and RF2 respectively.

The design is bi-directional; therefore, the RF input and output are interchangeable.

This DSA does not require blocking capacitors. If DC is presented at the RF port, add a blocking capacitor.

It is packaged in a RoHS2-compliant with QFN surface mount package.



24-lead 4mm x 4 mm x 0.9mm QFN

Figure 1. Package Type

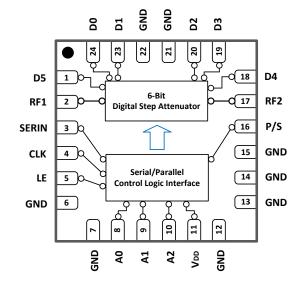


Figure 2. Functional Block Diagram

Application

- 5G/4G+/4G/3G Cellular Base station/Repeater Infrastructure
- **Digital Pre-Distortion**
- Distributed Antenna Systems, DAS
- Remote Radio Heads
- NFC Infrastructure
- Test Equipment and sensors
- Military Wireless system
- Cable Infrastructure
- General purpose Wireless

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Table 1. Electrical Specifications

Specifications are performance on the BeRex EVKit at VDD=3.3V, 25°C, 50Ω system. Performance were measured based on Typical application circuits Table 12. (See the Page 9)

	g Frequency Range		Frequency	Min	Тур	Max	Unit	
Atter	0			1		6000	MHz	
	nuation Range	0.5dB step			0 - 31.5		dB	
			1MHz - 1GHz		0.6		dB	
Incortion Loss ¹			1 - 2GHz		0.9		dB	
Inse	ertion Loss ¹	ATT = 0dB	2 - 3GHz		1.0		dB	
Parameter Operating Frequency Range Attenuation Range Insertion Loss¹ Attenuation Error Input Return Loss Output Return Loss Relative Phase Error Input 0.1dB Compression Point Input inearity Input IP3		3 - 4GHz		1.4		dB		
			4 - 6GHz		2.7		dB	
			1MHz - 1GHz			\pm (0.10 + 1.0% of attenuation state)	dB	
			1 - 2GHz			\pm (0.15 + 1.5% of attenuation state)	dB	
Atte	nuation Error	0-31.5dB / 0.5dB Step	2 - 3GHz			\pm (0.15 + 2.5% of attenuation state)	dB	
			3 - 4GHz			\pm (0.25 +3.5% of attenuation state)	dB	
			4 - 6GHz			\pm (0.25 +5.0% of attenuation state)	dB	
Input	t Return Loss	ATT = 0dB	1 - 4GHz		21		dB	
	2000		4 - 6GHz		9			
Outpu	ut Return Loss	ATT = 0dB	1 - 4GHz		21		dB	
			4 - 6GHz		9			
			1GHz		7			
			2GHz		15			
Relati	ve Phase Error	All states	3GHz		23		degree	
	Relative Phase Error		4GHz		31			
			5GHz		39			
			6GHz		44			
_	•	ATT = 0dB	3.5GHz		29		dBm	
		Pin = +18dBm/tone, $\triangle f = 10kHz$	2.5GHz		64			
		ATT = 0.0dB	3.5GHz		56		dBm	
		RF Input = RF1 Port	4.5GHz		57			
		Pin = +18dBm/tone, $\triangle f = 10kHz$	2.5GHz		54			
-		ATT = 31.5dB	3.5GHz		54		dBm	
Linearity	Input IP3	RF Input = RF1 Port	4.5GHz		62			
		Pin = +18dBm/tone, $\triangle f = 10kHz$	2.5GHz		64		dD.m.	
		ATT = 0.0dB	3.5GHz		58		dBm	
		RF Input = RF2 Port	4.5GHz		50			
		Pin= +18dBm/tone, $\triangle f = 10kHz$	2.5GHz		58		dD	
		ATT = 31.5dB	3.5GHz 4.5GHz		54 95		dBm	
DE Dici-	og / Falling Time	RF Input = RF2 Port 10%/90% RF	4.5GHz 2GHz		210		200	
		·			1		ns	
	ettling Time	50% LE control to 90% or 10% RF 50% LE to Max or Min Attenuation	2GHz 2GHz		500		ns ns	
Attenuation	Transient(envelope) ²	to settle within 0.05 dB of final value Positive Glitch, Any ATT step			0.3		dB	
Attenuation	Transient(envelope)	1 ostave ditteri, Arry Arri Step	1 - 5MHz		-132		ub	
Maximu	m Spurious Level	Measured at RF1 and RF2 port	>5MHz ³		-132 <-145		dBm/10Hz	

^{1.} The Evaluation board Kit insertion loss (PCB & RF Connector) is de-embedded.

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^{2.} Attenuation Transient is glitch level due to attenuation transitions

^{3.} No spurious signals were detected above 5MHz.



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Table 2. Electrical Specifications¹ (Optimized Return Loss Application)

Specifications are performance on the BeRex EVKit at VDD=3.3V, 25°C, 50 Ω system. Performance were measured based on Optimized Return Loss Application Circuits Table 13. (See the Page 14)

Parameter	Condition	Frequency	Min	Тур	Max	Unit
Operating Frequency Range			1		8000	MHz
Attenuation Range	0.5dB step			0 - 31.5		dB
		1MHz - 1GHz		0.6		dB
		1 - 2GHz		0.9		dB
Insertion Loss ²	ATT OID	2 - 3GHz		1.1		dB
Insertion Loss	ATT = 0dB	3 - 4GHz		1.1		dB
		4 - 6GHz		1.7		dB
		6 - 8GHz		2.5		dB
Attenuation Error		1MHz - 1GHz			\pm (0.10 + 1.0% of attenuation state)	dB
	0-31.5dB / 0.5dB Step	1 - 2GHz			\pm (0.15 + 1.5% of attenuation state)	dB
		2 - 3GHz			\pm (0.15 + 2.5% of attenuation state)	dB
Attenuation Error		3 - 4GHz			\pm (0.25 +3.5% of attenuation state)	dB
		4 - 6GHz			\pm (0.25 +5.0% of attenuation state)	dB
		6 - 8GHz			\pm (0.35 +7.0% of attenuation state)	dB
		1 - 4GHz		17		
Input Return Loss	ATT = 0dB	4 - 6GHz		15		dB
		6 - 8GHz		17		
		1 - 4GHz		17		
Output Return Loss	ATT = 0dB	4 - 6GHz		15		dB
		6 - 8GHz		16		
		1GHz		8		
		2GHz		15		
		3GHz		22		
Relative Phase Error	All states	4GHz		30		degree
Melative Filase Lift	All States	5GHz		38		degree
		6GHz		47		
		7GHz		52		
		8GHz		74		

^{1.} To improve Return loss above 4GHz, shunt capacitor 0.1pF was added to each RF1 & RF2. (See Optimized Return Loss application circuits Table 13 on page 14)

^{2.} The Evaluation board Kit insertion loss (PCB & RF Connector) is de-embedded.



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Table 3. Recommended Operating Condition

Parameter	Parameter		Condition	Min	Тур	Max	Unit
Supply Voltage		V_{DD}		2.7		5.5	٧
Supply Current		I _{DD}			200	310	μΑ
Digital Control Input	High	V _{CTLH}	V _{DD} =3.3V or 5V	1.17		3.6	V
Digital Control Input	Low	V_{CTLL}	V _{DD} =3.3V or 5V	-0.3		0.6	V
Operating Temperature	Range	T _{Case}	Exposed Paddle	-40		105	°C
RF Max Input Power		P _{IN_CW}	RF1 or RF2, CW (>50MHz)			24	dBm
Impedance	Impedance		Single ended	·	50		Ω

Specifications are not guaranteed over all recommended operating conditions.

Table 4. Absolute Maximum Ratings

Pa	rameter	Symbol	Min	Тур	Max	Unit
Supp	Supply Voltage		-0.3		5.5	V
Digital I	Input Voltage	V_{CTL}	-0.3		3.6	V
Maximum Input Power		P _{IN_CWMAX}			31	dBm
Storage Temperature	Storage	T _{ST}	-65		150	$^{\circ}$ C
remperature	Reflow	T_R			260	$^{\circ}$
	HBM ¹	ESD _{HBM}			±1000 (Class 1C)	V
ESD Sensitivity	CDM ²	ESD _{CDM}			±1000 (Class C3)	V

Operation of this device above any of these parameters may result in permanent damage.

^{1.} HBM : Human Body Model (JEDEC Standard JS-001-2017)

^{2.} CDM : Charged Device Model (JEDEC Standard JS-002-2018)

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Figure 3. Pin Configuration (Top View)

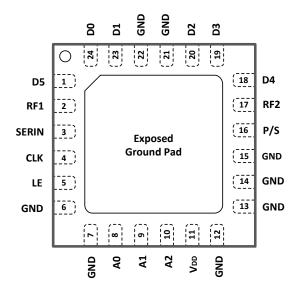


Table 5. Pin Descriptions

Pin	Pin name	Description
1	D5 ²	Attenuation control bit, 16dB
2	RF1 ¹	RF1 port (Attenuator RF Input)
2	KFI	This pin can also be used as an output because the design is bi-directional. RF1 is dc-coupled and matched to 50 Ω
3	SERIN	Serial interface data input
4	CLK	Serial interface clock input
5	LE	Latch Enable input
6, 7, 12, 13, 14, 15, 21, 22	Ground	Ground, These pins must be connected to ground
8	A0	Address bit A0 connection
9	A1	Address bit A1 connection
10	A2	Address bit A2 connection
11	VDD	Power Supply (nominal 3.3V)
16	P/S	Parallel/Serial Mode Select. For parallel mode operation, set this pin to LOW. For serial mode operation, set this pin to HIGH.
17	RF2 ¹	RF2 port (Attenuator RF Output.)
17	NF2	This pin can also be used as an input because the design is bi-directional. RF2 is dc-coupled and matched to 50 Ω .
18	D4 ²	Attenuation control bit, 8dB
19	D3 ²	Attenuation control bit, 4dB
20	D2 ²	Attenuation control bit, 2dB
23	D1 ²	Attenuation control bit, 1dB
24	DO ²	Attenuation control bit, 0.5dB
Pad	GND	Exposed pad: The exposed pad must be connected to ground for proper operation

^{1.} RF pins 2 and 17 must be at 0V DC. The RF pins do not require DC blocking capacitors for proper Operation if the 0V DC requirement is met

^{2.} Ground D0 - D5 if not in use or serial mode.



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Programming Options

BDA4630 can be programmed using either the parallel or serial interface, which is selectable via P/S pin(Pin16).

Serial mode is selected by pulling it to a voltage logic HIGH and parallel mode is selected by setting P/S to logic LOW.

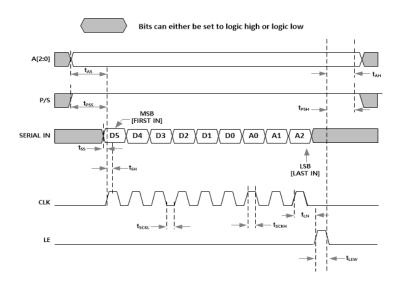
Serial Control Mode

The serial interface is a 6-bit shift register to shift in the data MSB (D5) first. When serial programming is used, It is recommended all the parallel control input pins (1, 18, 19, 20, 23, 24) are grounded. It is controlled by three CMOS-compatible signals: SERIN, Clock, and Latch Enable (LE).

Table 6. Truth Table for Serial Control Word

			Attenuation			
D5	D4	D3	D2	D1	D0	state
(MSB)					(LSB)	(dB)
LOW	LOW	LOW	LOW	LOW	LOW	0 (RL)
LOW	LOW	LOW	LOW	LOW	HIGH	0.5
LOW	LOW	LOW	LOW	HIGH	LOW	1
LOW	LOW	LOW	HIGH	LOW	LOW	2
LOW	LOW	HIGH	LOW	LOW	LOW	4
LOW	HIGH	LOW	LOW	LOW	LOW	8
HIGH	LOW	LOW	LOW	LOW	LOW	16
HIGH	HIGH	HIGH	HIGH	HIGH	HIGH	31.5

Figure 4. Serial Mode Timing Diagram



BDA4630 Serial mode is selected by pulling it to logic HIGH. The serial interface is a 9-bit shift register made up of two words. The first 6-bit word is the Attenuation word, which controls the DSA state. The second word is the address word, which uses 3 bits that must match the hard wired A0-A2 programming in order to change the DSA state. If no external connections are made to A0 – A2 then internally they will default to 000 due to internal pull down resistors. If these 3 external preset address bits are not matched with the SPI loaded address bits, then the current attenuator state will remain unchanged. This allows up to 8 serial-controlled devices to be used on a single board, which share a common SERIN, CLK and LE.

When serial programming is used, all the parallel control input pins 1, 18, 19, 20, 23, 24 can be left grounded or open.

Table 7. Serial Interface Timing Specifications

Symbol	Parameter	Min	Тур	Max	Unit
f_{CLK}	Serial data clock frequency			10	MHz
t _{PS}	Parallel data setup time	100			ns
t _{PH}	Parallel data hold time	100			ns
t _{AS}	Address setup time	100			ns
t _{AH}	Address hold time	100			ns
t _{PSS}	Parallel/Serial setup time	100			ns
t _{PSH}	Parallel/Serial hold time	100			ns
t _{SCK}	Minimum serial period	70			ns
t _{ss}	Serial Data setup time	10			ns
t _{SH}	Serial Data hold time	10			ns
t _{LN}	LE setup time	10			ns
t _{LEW}	Minimum LE pulse width	30			ns

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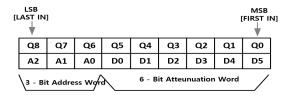


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Serial Register Map

The BDA4630 can be programmed via the serial control on the rising edge of Latch Enable (LE) which loads the last 6-bits attenuation word and 3-bits address word in the SHIFT Register. Serial Data is clocked in MSB(D5) first. The shift register must be loaded while LE is kept LOW to prevent changing the attenuation value during data is inputted.

Figure 5. Serial Register Map



The serial register consist of 9 bits as shown in Figure 5. First six bits from LSB are Attenuation word, three bits after that are Address word. The Attenuation word is DSA attenuation control bit and the Address word is static logical bit determined by A0, A1 and A2 digital inputs. The Attenuation word is derived directly from the value of the attenuation state. To find the attenuation word, multiply the value of the state by two because of 0.5dB step up to 31.5dB (total 63 Attenuation state), then convert to binary.

For example, to program attenuation 15.5dB state of addr[5] BDA4630:

Attenuation state 2 x 15.5 = 31

Serial Input: 101111110

Address state
Digital input of A2,A1,A0 pin = 101

D0—D5:111110

1	0	1	1	1	1	1	1	0
A2	Α1	Α0	D0	D1	D2	D3	D4	D5

Table 8. Truth Table for 3bit Address Word

Address	s Digital Contro			
A2	A1 A0		Address	Addr No.
(LSB)		(MSB)	Setting	
LOW	LOW	LOW	000	Addr[0]
LOW	LOW	HIGH	001	Addr[1]
LOW	HIGH	LOW	010	Addr[2]
LOW	HIGH	HIGH	011	Addr[3]
HIGH	LOW	LOW	100	Addr[4]
HIGH	LOW	HIGH	101	Addr[5]
HIGH	HIGH	LOW	110	Addr[6]
HIGH	HIGH	HIGH	111	Addr[7]

Table 9. Mode Selection

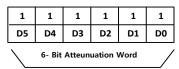
P/S	Control Mode
LOW	Parallel
HIGH	Serial

Power-UP states Settings

The BDA4630 will always initialize to the maximum attenuation setting (31.5 dB) on power-up for both the Serial and Latched Parallel modes of operation and will remain in this setting until the user latches in the next programming word. In Direct Parallel mode,

the DSA can be preset to any state within the 31.5 dB range by pre-setting the Parallel control pins prior to power-up. In this mode, there is a 400 µs delay between the time the DSA is powered-up to the time the desired state is set.

Figure 6. Default Attenuation word for Power-up state



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Programming Options

Parallel Control Mode

The parallel control interface has seven digital control input lines (D5 to D0) to set the attenuation value. D5 is the most significant bit (MSB) that selects the 16 dB attenuator stage, and D0 is the least significant bit (LSB) that selects the 0.5 dB attenuator stage.

Direct Parallel Mode

For direct parallel mode, The LE pin must be kept HIGH. The attenuation state is changed by the control voltage inputs (D0 to D5) directly. This mode is ideal for manual control of the attenuator. In this mode the device will immediately react to any voltage changes to the parallel control pins [pins 1, 18, 19, 20, 23, 24]. Use direct parallel mode for the fastest settling time.

Latched Parallel Mode

The LE pin must be kept LOW when changing the control voltage inputs (D0 to D5) to set the attenuation state. When the desired state is set, LE must be toggled HIGH to transfer the 6-bit data to the bypass switches of the attenuator array, and then toggled LOW to latch the change into the device until the next desired attenuation change (see Figure 7 and Table 10).

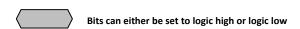
- Set P/S is logic LOW.
- Set LE to logic LOW.
- Adjust pins [1, 18, 19, 20, 23, 24] to the desired attenuation setting. (Note the device will not react to these pins while LE is a logic LOW).
- Pull LE to a logic HIGH. The device will then transition to the attenuation settings reflected by pins D5 - D0.
- If LE is pulled to a logic LOW then the attenuator will not change state.

Latched Parallel Mode implies a default state for when the device is first powered up with P/S pin set for logic LOW and LE logic LOW. In this case the default setting is <u>Maximum attenuation</u>.

Table 10. Truth Table for the Parallel Control Word

D5	D4	D3	D2	D1	D0	P/S	LE	Attenuation State(dB)
LOW	LOW	LOW	LOW	LOW	LOW	LOW	HIGH	0 (RL)
LOW	LOW	LOW	LOW	LOW	HIGH	LOW	HIGH	0.5
LOW	LOW	LOW	LOW	HIGH	LOW	LOW	HIGH	1.0
LOW	LOW	LOW	HIGH	LOW	LOW	LOW	HIGH	2.0
LOW	LOW	HIGH	LOW	LOW	LOW	LOW	HIGH	4.0
LOW	HIGH	LOW	LOW	LOW	LOW	LOW	HIGH	8.0
HIGH	LOW	LOW	LOW	LOW	LOW	LOW	HIGH	16.0
HIGH	HIGH	HIGH	HIGH	HIGH	HIGH	LOW	HIGH	31.5

Figure 7. Latched Parallel Mode Timing Diagram



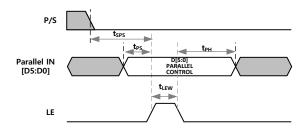


Table 11. Parallel Interface Timing Specifications

Symbol	Parameter	Min	Тур	Max	Unit
$t_{\scriptscriptstyleSPS}$	Serial to Parallel Mode Setup Time	100			ns
t _{LEW}	Minimum LE pulse width	10			ns
t _{PH}	Data hold time from LE	10			ns
t _{PS}	Data setup time to LE	10			ns

Switching Feature Description

Glitch-Safe Attenuation State Transient

The BDA4630 is the latest product applied *Glitch-Safe* technology with less than 1dB ringing (pos/neg) across the attenuation range when changing attenuation states. This technology protects Amplifiers or ADC during transitions between attenuation states. (see Figure 32,33).

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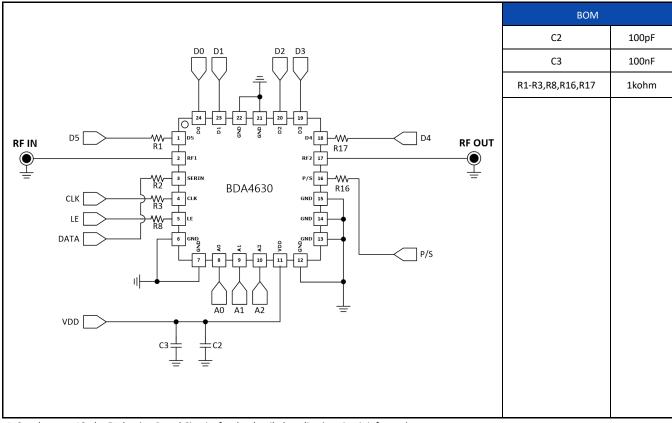


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Typical RF Performance Plot - BDA4630 EVK - PCB (Typical Application Circuits)

Typical Performance Data @ 25°C and VDD = 3.3V, EVKit RF connector and board losses are de-embedded, unless otherwise noted

Table 12. Typical Application Circuits



1. See the page 18 the Evaluation Board Circuits for the detailed application circuit information.



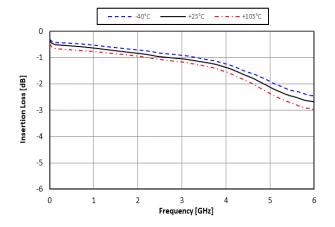
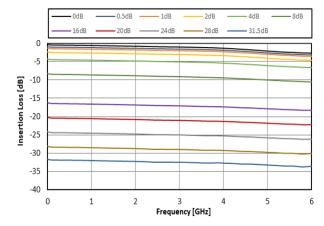


Figure 9. Insertion Loss vs ATT Setting



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Typical RF Performance Plot - BDA4630 EVK - PCB (Typical Application Circuits)

Typical Performance Data @ 25°C and VDD = 3.3V, EVKit RF connector and board losses are de-embedded, unless otherwise noted

Figure 10. Input Return Loss vs ATT Setting

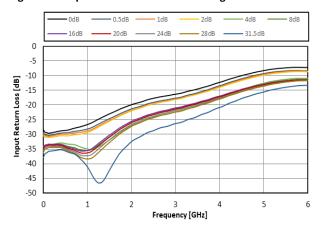


Figure 12. Input Return Loss vs Temp. @ ATT = 16dB

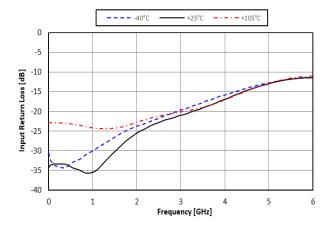


Figure 14. Relative Phase Error vs ATT Setting

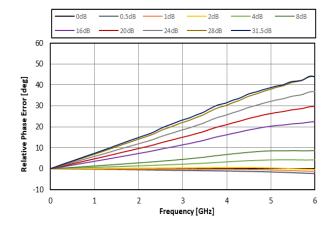


Figure 11. Output Return Loss vs ATT Setting

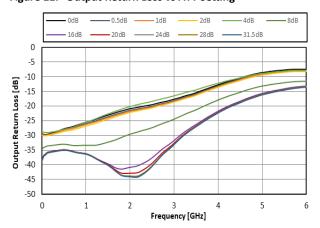


Figure 13. Output Return Loss vs Temp. @ ATT = 16dB

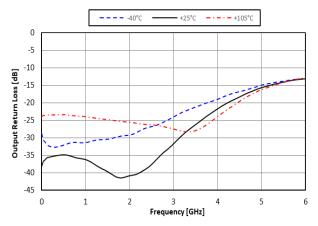
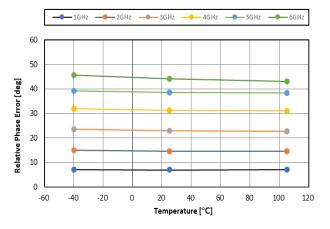


Figure 15. Relative Phase Error vs Frequency @ ATT = 31.5dB



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Typical RF Performance Plot - BDA4630 EVK - PCB (Typical Application Circuits)

Typical Performance Data @ 25°C and VDD = 3.3V, EVKit RF connector and board losses are de-embedded, unless otherwise noted

Figure 16. ATT Error vs Temp. @ 900MHz

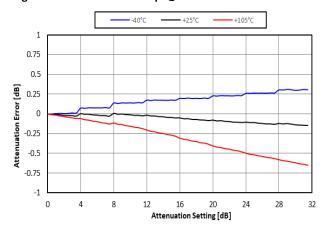


Figure 17. ATT Error vs Temp. @ 1800MHz

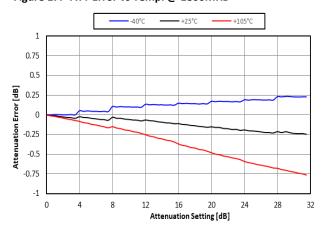


Figure 18. ATT Error vs Temp. @ 2200MHz

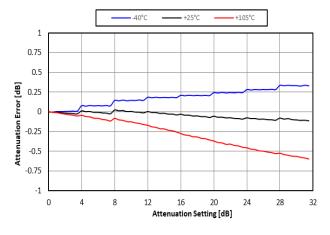


Figure 19. ATT Error vs Temp. @ 3500MHz

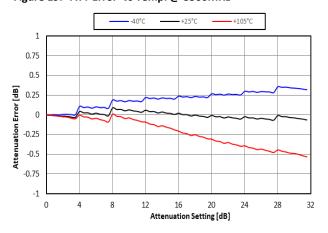


Figure 20. ATT Error vs Temp. @ 4600MHz

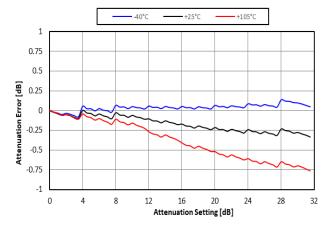
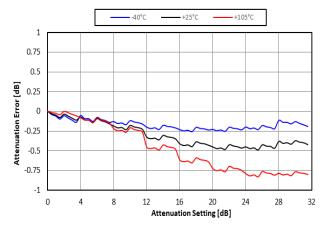


Figure 21. ATT Error vs Temp. @ 5800MHz



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1MHz - 8000MHz

Typical RF Performance Plot - BDA4630 EVK - PCB (Typical Application Circuits)

Typical Performance Data @ 25°C and VDD = 3.3V, EVKit RF connector and board losses are de-embedded, unless otherwise noted

Figure 22. IIP3 vs Temp. @ 2500MHz

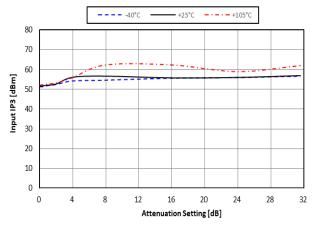


Figure 24. IIP3 vs Temp. @ 4500MHz

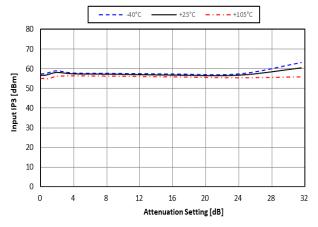


Figure 26. Input 0.1dB Compression vs Temp. @ 3500MHz

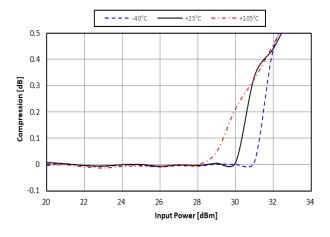


Figure 23. IIP3 vs Temp. @ 3500MHz

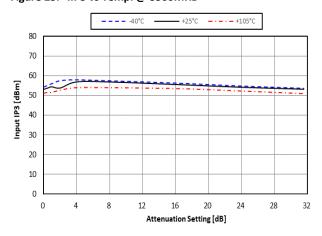


Figure 25. Input 0.1dB Compression vs Temp. @ 2500MHz

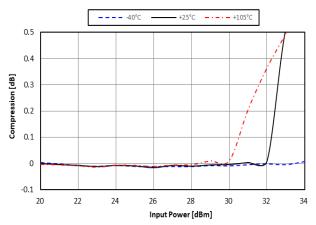
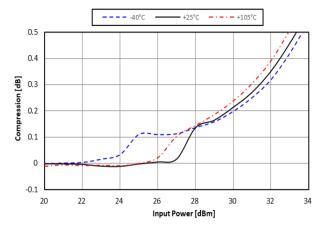


Figure 27. Input 0.1dB Compression vs Temp. @ 4500MHz



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Typical RF Performance Plot - BDA4630 EVK - PCB (Typical Application Circuits)

Typical Performance Data @ 25°C and V_{DD} = 3.3V, EVKit RF connector and board losses are de-embedded, unless otherwise noted

Figure 28. 0.5dB Step ATT vs Frequency

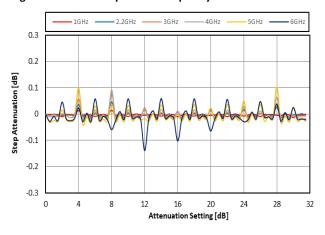


Figure 30. Major State Bit Error vs ATT Setting

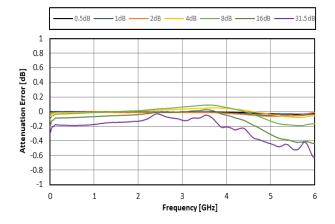


Figure 32. ATT Transient (15.5 to 16dB, Pin=18dBm)

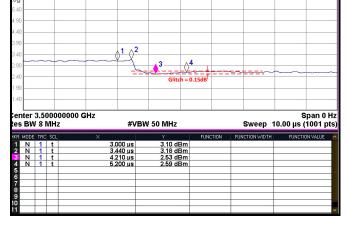


Figure 29. 0.5dB Step ATT Actual vs Frequency

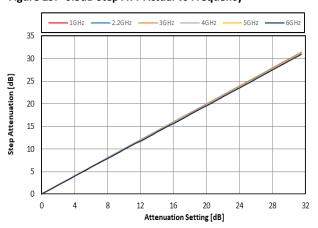


Figure 31. 0.5dB Step ATT Error vs Frequency

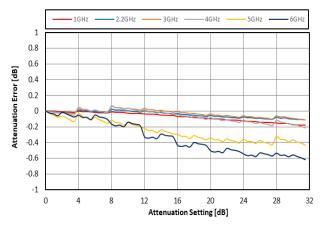
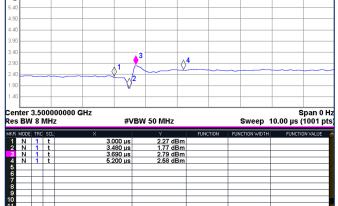


Figure 33. ATT Transient (16 to 15.5dB, Pin=18dBm)



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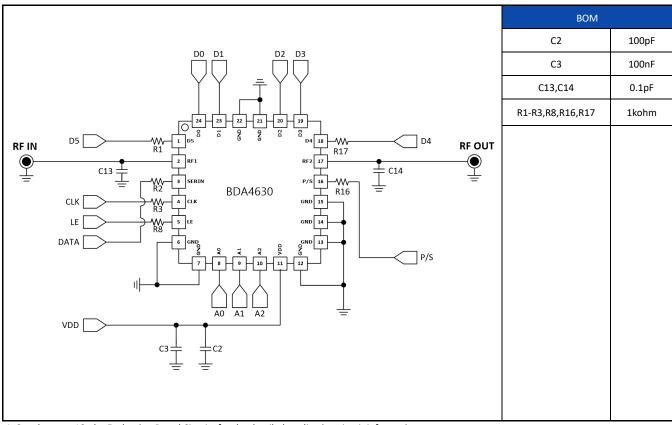


1MHz - 8000MHz

Typical RF Performance Plot - BDA4630 EVK - PCB (Optimized Return Loss Application Circuits)

Typical Performance Data @ 25°C and V_{DD} = 3.3V, EVKit RF connector and board losses are de-embedded, unless otherwise noted

Table 13. Optimized Return Loss Application Circuits for 4GHz - 8GHz



- 1. See the page 18 the Evaluation Board Circuits for the detailed application circuit information.
- 2. In order to optimized Return loss for above 4GHz, shunt capacitor 0.1pF was added near RF1 & RF2, respectively.

Figure 34. Insertion Loss vs Temp.

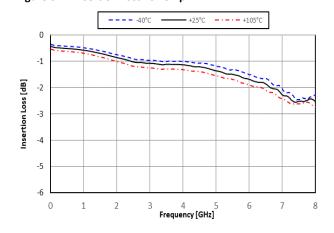
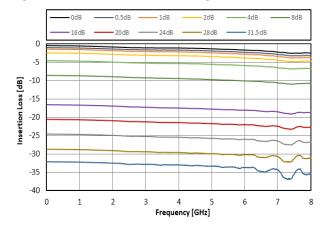


Figure 35. Insertion Loss vs ATT Setting



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1MHz - 8000MHz

Typical RF Performance Plot - BDA4630 EVK - PCB (Optimized Return Loss Application Circuits)

Typical Performance Data @ 25°C and V_{DD} = 3.3V, EVKit RF connector and board losses are de-embedded, unless otherwise noted

Figure 36. Input Return Loss vs ATT Setting

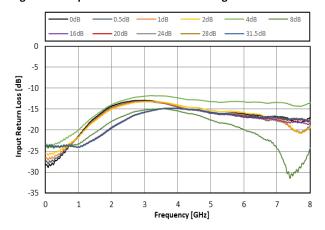


Figure 37. Output Return Loss vs ATT Setting

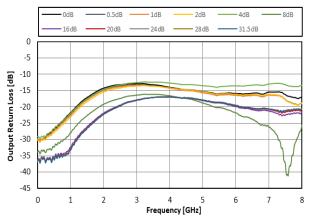


Figure 38. Input Return Loss vs Temp. @ ATT = 0dB

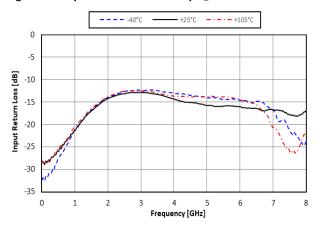


Figure 39. Output Return Loss vs Temp. @ ATT = 0dB

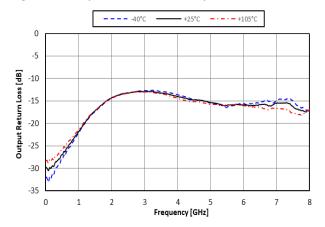


Figure 40. Relative Phase Error vs ATT Setting

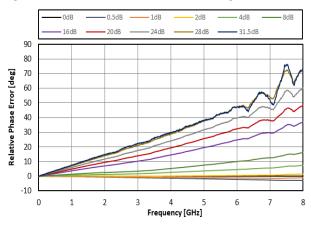
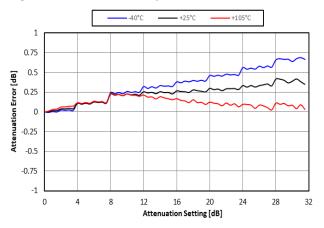


Figure 41. ATT Error vs Temp. @ 3500MHz



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Typical RF Performance Plot - BDA4630 EVK - PCB (Optimized Return Loss Application Circuits)

Typical Performance Data @ 25°C and V_{DD} = 3.3V, EVKit RF connector and board losses are de-embedded, unless otherwise noted

Figure 42. ATT Error vs Temp. @ 4600MHz

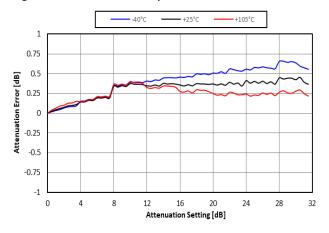


Figure 43. ATT Error vs Temp. @ 5800MHz

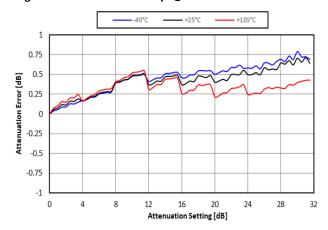


Figure 44. ATT Error vs Temp. @ 7200MHz

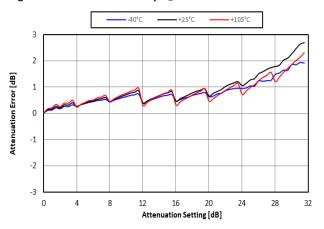


Figure 45. 0.5dB Step Actual ATT vs Frequency

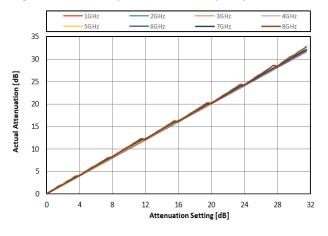


Figure 46. Major State Bit Error vs ATT Setting

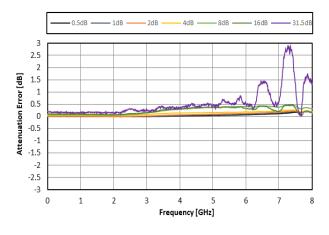
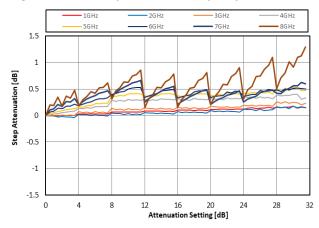


Figure 47. 0.5dB Step ATT Error vs Frequency



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1MHz - 8000MHz

BDA4630 Evaluation board Kit Description

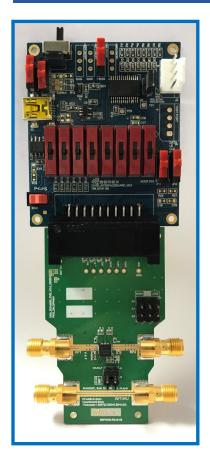


Figure 48. BDA4630 EVK

Evaluation board Kit Introduction

BDA4630 Evaluation Kit is made up of a combination of an RF board and an interface board

The schematic of the BDA4630 evaluation RF board is shown in Figure 48. The BDA4630 evaluation RF board is constructed of a 4-layer material with a copper thickness of 0.7 mil on each layer. Every copper layer is separated with a dielectric material. The top dielectric material is 8 mils RO4003. The middle and bottom dielectric materials are FR-4, used for mechanical strength and overall board thickness of approximately 1.63mm.

BDA4630 Evaluation INTERFACE board is assembled with a SP3T switches(D0 $^{\sim}$ D5,LE), SP2T mechanical switch (P/S), and several header & switch.

Evaluation Board Programming Using USB Interface

In order to evaluate the BDA4630 performance, the Application Software has to be installed on your computer. And The DSA application software GUI supports Latched Parallel and Serial modes. software can be downloaded from BeRex's website

Serial Control Mode

- Set the Address Jumper (A0, A1, A2) to HIGH or LOW (Refer to Address Table 8)
- Connect directly the Evaluation INTEFRACE board USB port(J3) to PC
- Set the direction of P<->S Switch to S direction (P/S Logic HIGH)
- Set the D0~D5, LE switch to the middle position.
- Operate the 0~31.5dB attenuation state in GUI and then control the DSA

Latched Parallel Control Mode

- Connect directly the Evaluation INTEFRACE board USB port(J3) to PC
- Set the direction of P<->S Switch to P direction (P/S Logic LOW)
- Set the D0~D5, LE switch to the middle position.
- Operate the 0~31.5dB attenuation state in GUI and then control the DSA

Direct Parallel Control Mode

- Set the direction of P<->S Switch to P direction (P/S Logic LOW)
- Set LE switch to the LOW Position
- For the setting to attenuation state, D0~D5 switches can be combined in manually program, refer to Table 10

Please refer to user manual for more detailed operation method of BDA4630 EVK.



1MHz - 8000MHz

BDA4630 Evaluation board Kit Description

Figure 49. Evaluation Board Kit Schematic Diagram

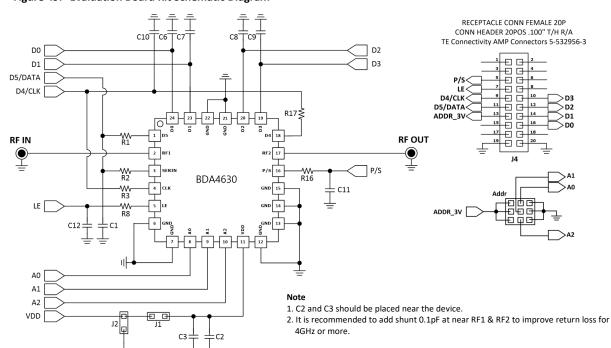


Figure 50. Evaluation Board PCB Layout Information

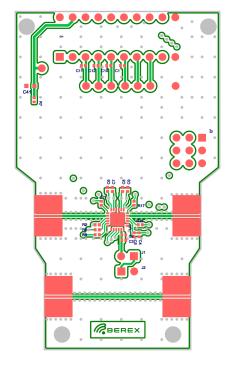
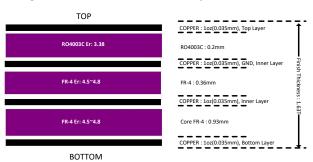


Table 14. Bill of Material - Evaluation Board

No.	Ref Des	Part Qty	Value	Description	Remark
1	C2	1	100pF	CAP, 0402, CHIP Ceramic, ±0.25%	
2	C3	1	100nF	CAP, 0402, CHIP Ceramic, ±0.25%	
3	R1,R2,R3,R8,R16,R17	6	1k ohm	RES, 0402, CHIP, ±5%	
4	U1	1	Chip	DSA, BDA4630 QFN4x4 24L	
5	SMA1, SMA2	2	CON	SMA END LAUNCH	
6	J1, J2	2	CON	Header 2.54mm 2pin	
7	J3	1	CON	Header array 2.54mm 3pin x 3	
8	J4	1	CON	Receptacle connector 20pin	
9	R7,C1,C4-C12,C41	12	NC	Not Connected	

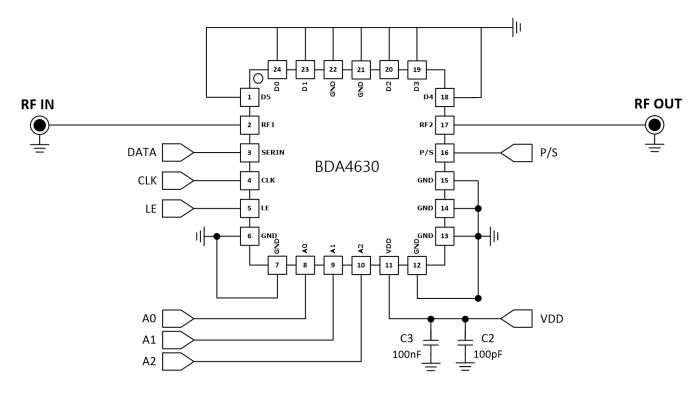
Figure 51. Evaluation Board PCB Layer Information



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1MHz - 8000MHz

Figure 52. Recommended Serial mode Application Circuit Schematic



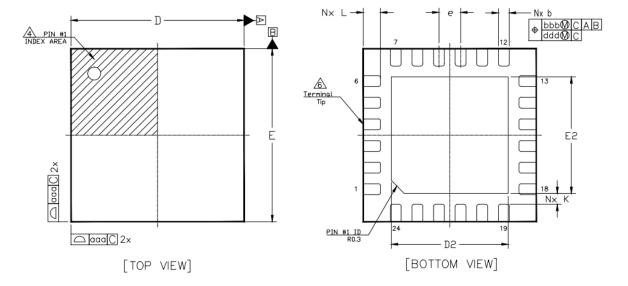
Note: 1. C1 and C2 should be placed near the device.

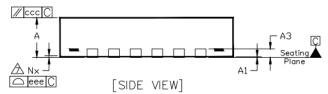
- 2. Recommended to add pull-down resistor(R1) at the LE pin.
- 3. Addressable Pin A0,A1,A2 can be set according to the specified address. If the specified address is 000, All addressable pin(A0,A1,A2) should be grounded.



1MHz - 8000MHz

Figure 53. Packing Outline Dimension





NOTE:

- 1. Dimensioning and tolerancing conform to ASME Y14.5-2009.
- 2. All dimensions are in millimeters.
- 3. N is the total number of terminals.
- 4. The location of the marked terminal #1 identifier is within the hatched area.
- 5. ND and NE refer to the number of terminals on each D and E side respectively.
- 6. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip. If the terminal has a radius on the other end of it, dimension b should not be measured in that radius area.
- 7. Coplanarity applies to the terminals and all other bottom surface metallization

		Dimension Table	!	
Symbol		NOTE		
	MINIMUM	NOMINAL	MAXIMUM	NOTE
Α	0.80	0.90	1.00	
A1	0.00	0.02	0.05	
А3		0.203 Ref		
b	0.2	0.25	0.3	6
D		4.0 BSC		
E		4.0 BSC		
е		0.5 BSC		
D2	2.65	2.70	2.75	
E2	2.65	2.70	2.75	
K	0.2			
L	0.3	0.4	0.5	
aaa		0.05		
bbb		0.10		
ссс		0.10		
ddd		0.05		
eee		0.08		
N		24		3
NE		6		5

1MHz - 8000MHz

Figure 54. Recommend Land Pattern

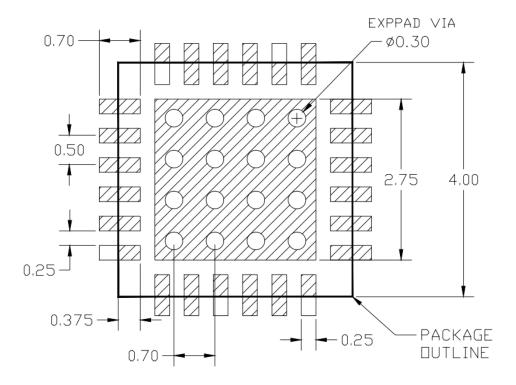


Figure 55. Package Marking

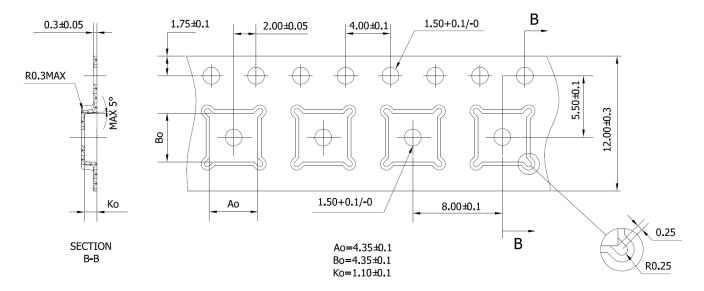


Marking information:				
BDA4630	Device Name			
YY	Year			
ww	Work Week			
XX	LOT Number			



1MHz - 8000MHz

Figure 56. Tape & Reel



- NOTES: 1 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ±0.2 2 CAMBER IN COMPLANCE WITH EIA 481 3 POCKET POSITION RELITIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET,NOT POCKET HOLE

Packaging information:				
Tape Width	12mm			
Reel Size	7inch			
Device Cavity Pitch	8mm			
Devices Per Reel	1k			



1MHz - 8000MHz

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD Rating: Class 1C Value: ±1000V

Test: Human Body Model (HBM)
Standard: JEDEC Standard JS-001-2017

ESD Rating: Class C3
Value: ±1000V

Test: Charged Device Model (CDM)
Standard: JEDEC Standard JS-002-2018

MSL Rating: Level 1 at +260°C convection reflow

Standard: JEDEC Standard J-STD-020



Proper ESD procedures should be followed when handling this device.

RoHS Compliance

This part is compliant with Restrictions on the use of certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

NATO CAGE code:

2 N 9	6	F
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Specifications and information are subject to change without notice.